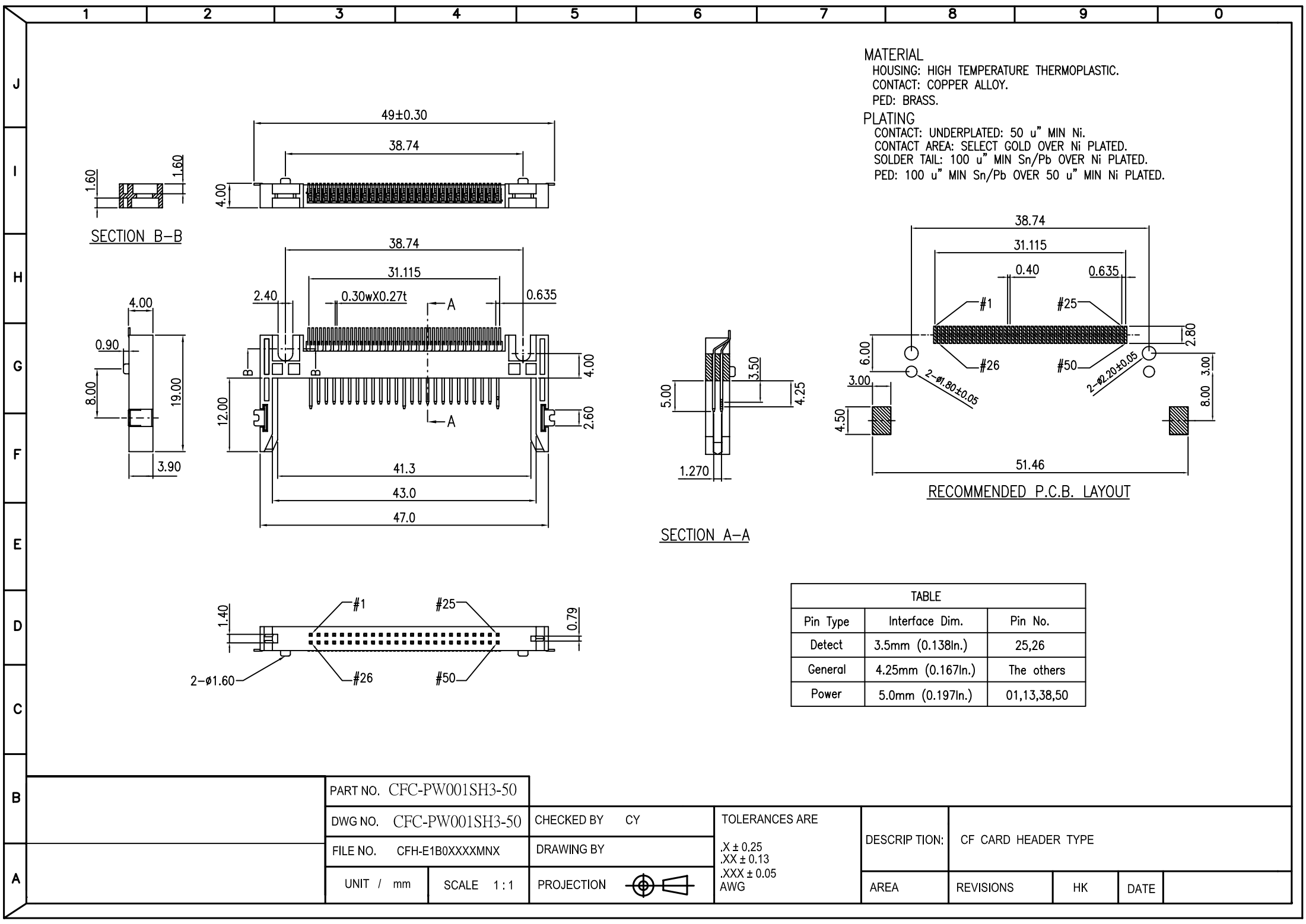




MATERIAL
HOUSING: HIGH TEMPERATURE THERMOPLASTIC.
CONTACT: COPPER ALLOY.
PED: BRASS.

PLATING
CONTACT: UNDERPLATED: 50 u" MIN Ni.
CONTACT AREA: SELECT GOLD OVER Ni PLATED.
SOLDER TAIL: 100 u" MIN Sn/Pb OVER Ni PLATED.
PED: 100 u" MIN Sn/Pb OVER 50 u" MIN Ni PLATED.

TABLE		
Pin Type	Interface Dim.	Pin No.
Detect	3.5mm (0.138In.)	25,26
General	4.25mm (0.167In.)	The others
Power	5.0mm (0.197In.)	01,13,38,50

PART NO. CFC-PW001SH3-50											
DWG NO. CFC-PW001SH3-50		CHECKED BY CY		TOLERANCES ARE .X ± 0.25 .XX ± 0.13 .XXX ± 0.05 AWG		DESCRIP TION:	CF CARD HEADER TYPE				
FILE NO. CFH-E1B0XXXXMNX		DRAWING BY									
UNIT / mm	SCALE 1 : 1	PROJECTION				AREA	REVISIONS		HK	DATE	